

	L #	Hits	Search Text	DBs	Time Stamp
1	L4	0	drb and active and heat near2 spreading	USPA T; US-P GPUB ; EPO; JPO; DERW ENT; IBM_ TDB	2003/03/2 6 15:38
2	L5	10	dbr and active and heat near2 spreading	USPA T; US-P GPUB ; EPO; JPO; DERW ENT; IBM_ TDB	2003/03/2 6 15:49
3	L6	8	dbr and active and heat adj3 layers	USPA T; US-P GPUB ; EPO; JPO; DERW ENT; IBM_ TDB	2003/03/2 6 15:56
4	L7	0	dbr and active and heatsink adj3 layers	USPA T; US-P GPUB ; EPO; JPO; DERW ENT; IBM_ TDB	2003/03/2 6 15:56

	L #	Hits	Search Text	DBs	Time Stamp
5	L8	1	dbr and active and dissipation adj3 layers	USPA T; US-P GPUB ; EPO; JPO; DERW ENT; IBM_ TDB	2003/03/2 6 15:57
6	L9	0	dbr and active and dissipating adj3 layers	USPA T; US-P GPUB ; EPO; JPO; DERW ENT; IBM_ TDB	2003/03/2 6 15:57
7	L10	0	dbr and active and cooling adj3 layers	USPA T; US-P GPUB ; EPO; JPO; DERW ENT; IBM_ TDB	2003/03/2 6 15:58
8	L11	13	vcsl and active and heat adj3 layers	USPA T; US-P GPUB ; EPO; JPO; DERW ENT; IBM_ TDB	2003/03/2 6 16:11

	L #	Hits	Search Text	DBs	Time Stamp
9	L12	6	vcSEL and active and heating adj3 layers	USPAT; US-PGPUB ; EPO; JPO; DERWENT; IBM-TDB	2003/03/26 16:20
10	L13	55	vcSEL and active and DBR and InP near4 layers	USPAT; US-PGPUB ; EPO; JPO; DERWENT; IBM-TDB	2003/03/26 16:54
11	L14	64	vcSEL and active and DBR and InP near4 layer	USPAT; US-PGPUB ; EPO; JPO; DERWENT; IBM-TDB	2003/03/26 16:54
12	L15	38	vcSEL and active and DBR and InP near4 n	USPAT; US-PGPUB ; EPO; JPO; DERWENT; IBM-TDB	2003/03/26 16:55